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**BA12001B / BA12003B / BA12003BF / BA12004B**

Standard ICs

# High voltage, high current Darlington transistor array

## **BA12001B / BA12003B / BA12003BF / BA12004B**

The BA12001B, BA12003B, BA12003BF, and BA12004B are high voltage, high current, high sustain voltage transistor arrays consisting of seven circuits of Darlington transistors.

Because it incorporates built-in surge-absorbing diodes and base current-control resistors needed when using inductive loads such as relay coils, attachments can be kept to a minimum.

With an output sustain voltage as high as 60V and an output current (sink current) of 500mA, this product is ideal for use with various drivers and as an interface with other elements.

### ●Applications

Drivers for LEDs, lamps, relays and solenoids

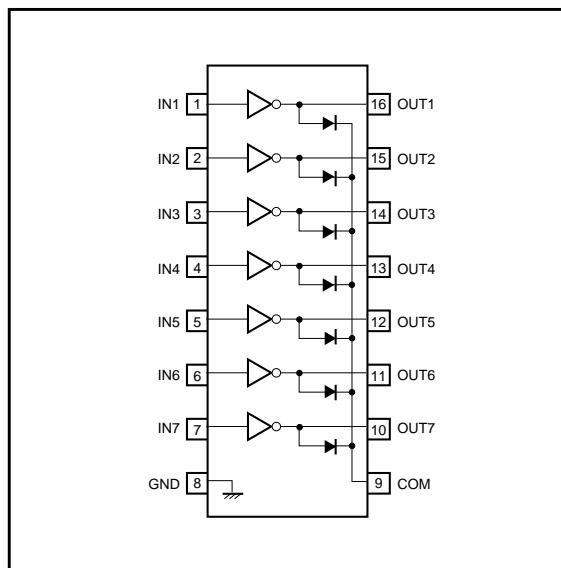
Interface with other elements

### ●Features

- 1) High output current. ( $I_{out}=500mA$  Max.)
- 2) High output sustain voltage. ( $V_{out}=50V$  Max.)
- 3) Seven Darlington transistors built in.
- 4) Built-in surge-absorbing clamp diode.

(Note : Refer to the "Reference items when using in application." )

### ●Block diagram



## BA12001B / BA12003B / BA12003BF / BA12004B Standard ICs

### ●Internal circuit configuration

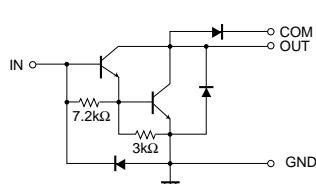


Fig.1 BA12001B

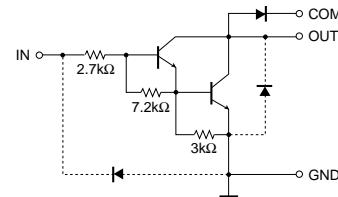


Fig.2 BA12003B / BF

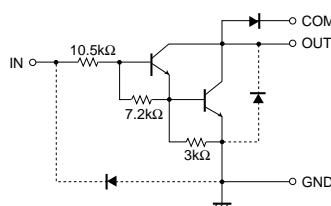


Fig.3 BA12004B

### ●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Power supply voltage	V <sub>CE</sub>	60	V
Input voltage other than BA12001B	V <sub>IN</sub>	-0.5~+30	V
Input current BA12001B	I <sub>IN</sub>	25	mA / unit
Output current	I <sub>OUT</sub>	500	mA / unit
Ground pin current	I <sub>GND</sub>	2.3* <sup>1</sup>	A
Power dissipation	P <sub>d</sub>	1250* <sup>2</sup>	mW
SOP package		625* <sup>3</sup>	
Diode reverse voltage	V <sub>R</sub>	60	V
Diode forward current	I <sub>F</sub>	500	mA
Operating temperature	T <sub>opr</sub>	-25~+75	°C
Storage temperature	T <sub>stg</sub>	-55~+150	°C

\*1 Pulse width ≤ 20ms, duty cycle ≤ 10%, same current for all 7 circuits

\*2 Reduced by 10mW for each increase in Ta of 1°C over 25°C .

\*3 Reduced by 50mW for each increase in Ta of 1°C over 25°C .

### ●Recommended operating conditions (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output current	I <sub>OUT</sub>	-	-	350	mA	Fig.9, 10
Power supply voltage	V <sub>CE</sub>	-	-	55	V	-
Input voltage (excluding BA12001B)	V <sub>IN</sub>	-	-	30	V	-
Input current (BA12001B only)	I <sub>IN</sub>	-	-	25	mA / unit	-

## BA12001B / BA12003B / BA12003BF / BA12004B

### Standard ICs

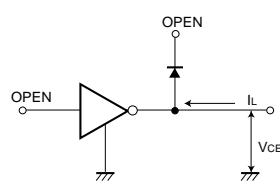
● **Electrical characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output leakage current	$I_L$	—	0	10	$\mu A$	$V_{CE} = 60V$
DC current transfer ratio	$h_{FE}$	1000	2400	—	V	$V_{CE} = 2V$ , $I_{OUT} = 350mA$
Output saturation voltage	$V_{CE(sat)}$	—	0.94	1.1	V	$I_{OUT} = 100mA$ , $I_{IN} = 250\mu A$
			1.14	1.3	V	$I_{OUT} = 200mA$ , $I_{IN} = 350\mu A$
			1.46	1.6	V	$I_{OUT} = 350mA$ , $I_{IN} = 500\mu A$
Input voltage	$V_{IN}$	—	1.75	2	V	$V_{CE} = 2V$ , $I_{OUT} = 100mA$
			2.53	5	V	$V_{CE} = 2V$ , $I_{OUT} = 200mA$
BA12003B / BF	$V_{IN}$	—	1.91	2.4	V	$V_{CE} = 2V$ , $I_{OUT} = 350mA$
			2.75	6	V	$V_{CE} = 2V$ , $I_{OUT} = 350mA$
BA12004B	$V_{IN}$	—	2.17	3.4	V	$V_{CE} = 2V$ , $I_{OUT} = 350mA$
			3.27	8	V	$V_{CE} = 2V$ , $I_{OUT} = 350mA$
Input current	$I_{IN}$	—	0.90	1.35	mA	$V_{IN} = 3.85V$
			0.39	0.5	mA	$V_{IN} = 5V$
Diode reverse current	$I_R$	—	0	50	$\mu A$	$V_R = 60V$
Diode forward voltage	$V_F$	—	1.73	2	V	$I_F = 350mA$
Input capacitance	$C_{IN}$	—	30	—	pF	$V_{IN} = 0V$ , $f = 1MHz$

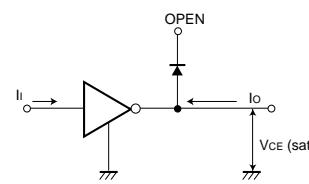
Note: Input voltage and input current for BA12001 vary based on external resistor.

● **Measurement circuits**

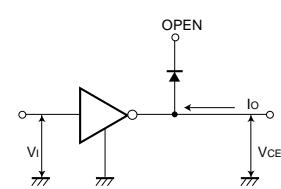
(1) Output leakage current  $I_L$



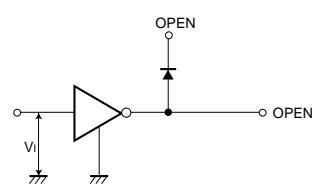
(2) DC current transfer ratio  
Output saturation voltage



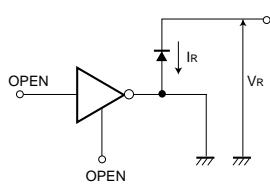
(3) Input voltage  $V_{IN}$



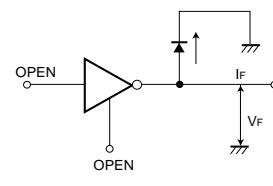
(4) Input current  $I_{IN}$



(5) Diode reverse current  $I_R$



(6) Diode forward voltage  $V_F$



(7) Input capacitance  $C_{IN}$

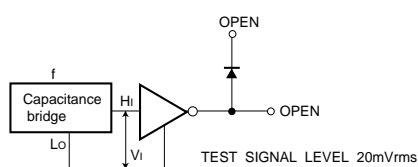


Fig.4

## BA12001B / BA12003B / BA12003BF / BA12004B

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#### ● Application example

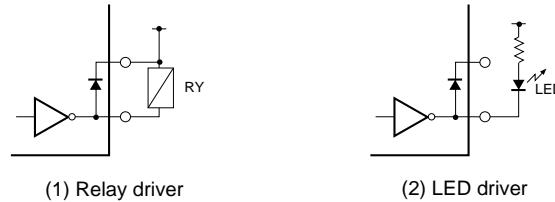


Fig.5

#### ● Application notes

The BA12001B is a transistor array which can be directly coupled to a general logic circuit such as PMOS, CMOS, or TTL.

A current limiting resistor needs to be connected in series with the input.

The BA12003B / BF can be coupled directly to TTL or CMOS output (when operating at 5V). In order to limit the input current to a stable value, resistors are connected in series to each of the inputs.

The BA12004B is designed for direct coupling to CMOS or PMOS output using a 6 to 15V power supply voltage. In order to limit the input current to a stable value, resistors are connected in series to each of the inputs.

The load for each of these products should be connected between the driver output and the power supply. To protect the IC from excessive swing voltage, the COM pin (Pin 9) should be connected to the power supply.

Fig.6 shows the configuration of the on-chip diode for surge absorption.

In the construction of the surge-absorbing diode, there is an N-P junction between the N-layer (N-well + BL) and the substrate (P-sub) so that when the diode is on, current flows from the output pin to the substrate. In terms of the vertical construction, this diode is configured similar to a PNP transistor. When using the surge-absorbing diode, take appropriate measures regarding the thermal characteristics of the design considering the current that will be handled.

Also, if motor back-rush current or other conditions that will result in continued surge current to flow to the surge-absorbing diode can be foreseen, we strongly recommend connecting a Schottky barrier diode (or other type of diode with a low forward voltage) in parallel with the surge-absorbing diode to construct a bypass route for the surge current.

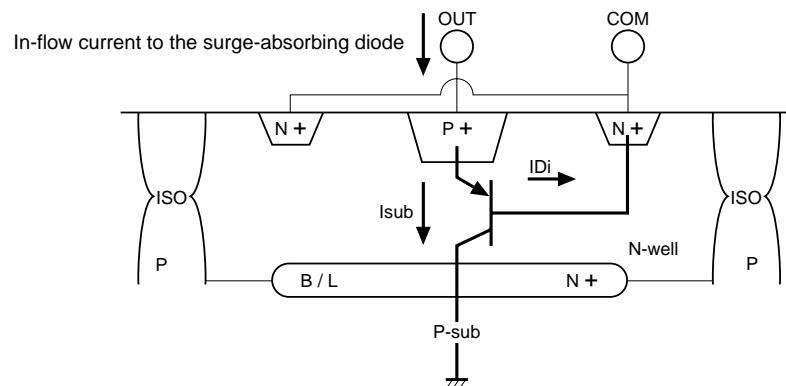


Fig.6 Vertical construction of the surge-absorbing diode

## BA12001B / BA12003B / BA12003BF / BA12004B

### Standard ICs

#### ● Electrical characteristic curves

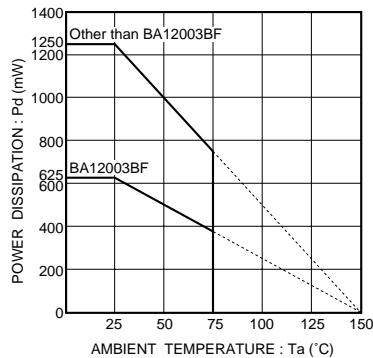


Fig.7 Power dissipation vs. ambient temperature

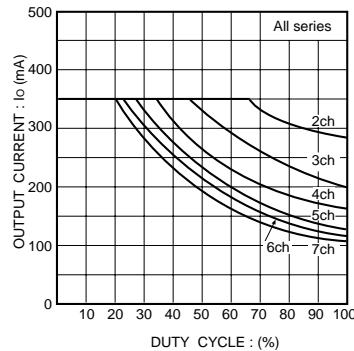


Fig.8 Output conditions (I)

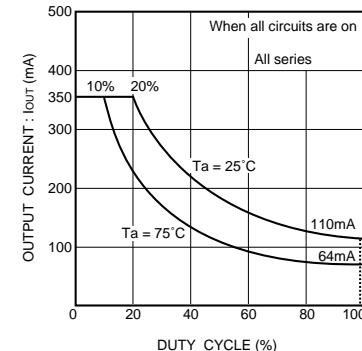


Fig.9 Output conditions (II)

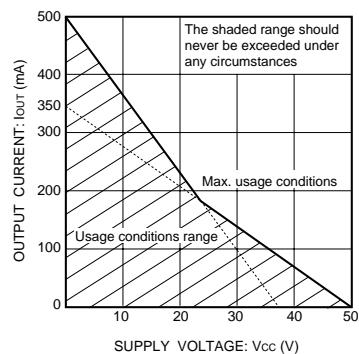


Fig.10 Usage conditions range per circuit

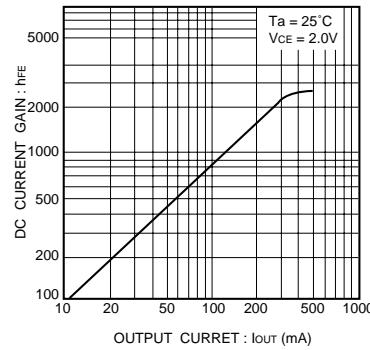


Fig.11 DC current transfer ratio vs. output current

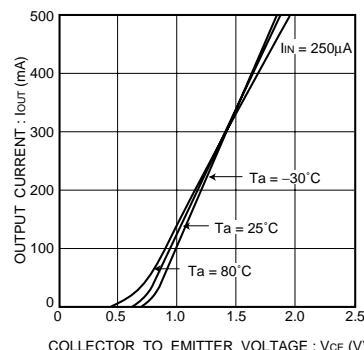


Fig.12 Output current vs. voltage between collector and emitter

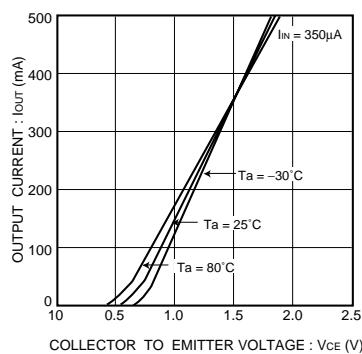


Fig.13 Output current vs. voltage between collector and emitter

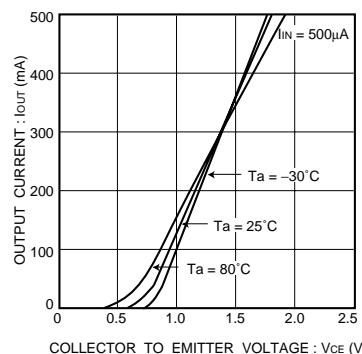


Fig.14 Output current vs. voltage between collector and emitter

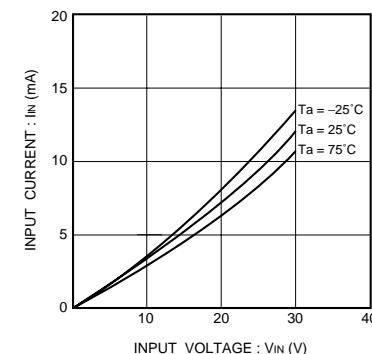


Fig.15 Input current vs. input voltage (BA12003B / BF)

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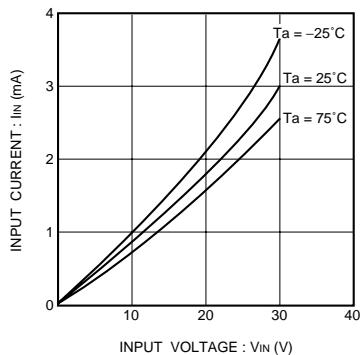


Fig.16 Input current vs. input voltage (BA12004B)

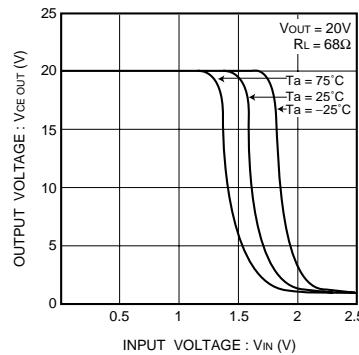


Fig.17 Output voltage vs. input voltage (BA12003B / BF)

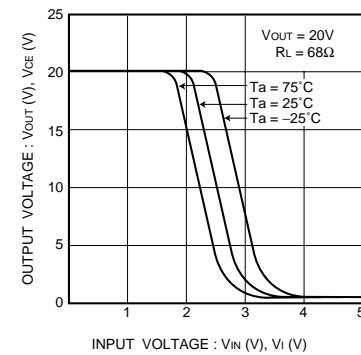
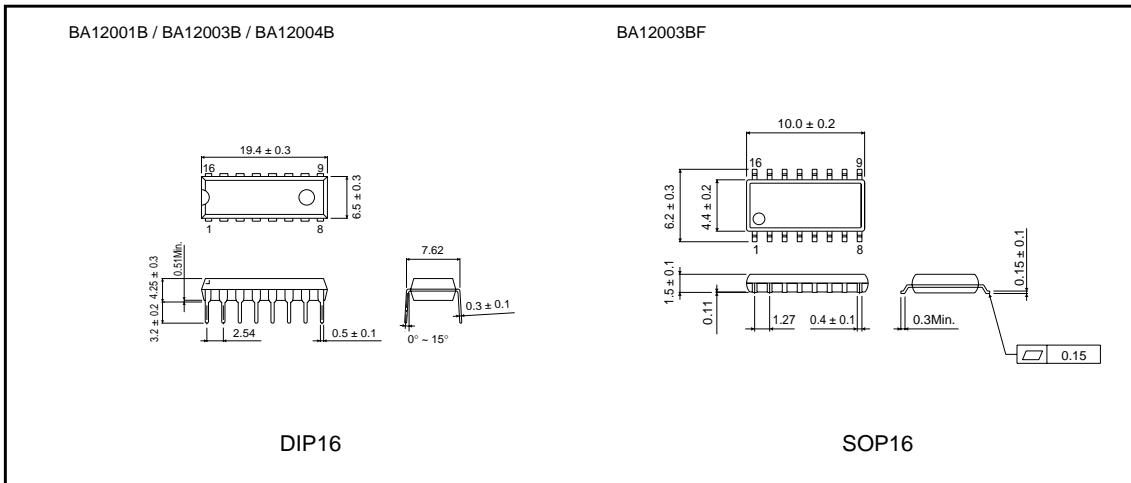


Fig.18 Output voltage vs. input voltage (BA12004B)

### ●External dimensions (Units : mm)



## Appendix

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